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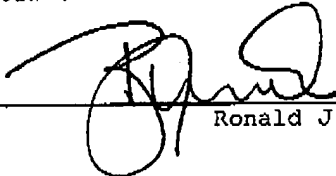
NOV 16 2005

**PATENT
NON-FINAL**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/501,522 Confirmation No. 4666
Applicant : Naoshi ADACHI et al.
Filed : July 16, 2004
TC/A.U. : 2812
Examiner : Stanetta D. Issac
Dkt. No. : ABE-025
Cust. No. : 20374

I hereby certify that this paper is being
facsimile transmitted on November 16, 2005,
to the United States Patent and Trademark
Office to facsimile number (571)273-8300.



Ronald J. Kubovcik

**RESPONSE UNDER 37 C.F.R. § 1.111
TO THE FIRST OFFICE ACTION DATED JUNE 16, 2005**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

November 16, 2005

Sir:

This paper is submitted in response to the Office Action dated
June 16, 2005. A petition for a two-month extension of the period
for responding to the Action is being filed concurrently herewith.

Please amend the application as directed below and consider
the remarks that follow.

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PATENT APPLN. NO. 10/501,522
RESPONSE UNDER 37 C.F.R. §1.111

**PATENT
NON-FINAL**

IN THE TITLE:

Please replace the title of the invention with the following
amended title:

~~PASTED~~ BONDED SOI SUBSTRATE, ~~PROCESS FOR PRODUCING THE SAME~~
MANUFACTURING METHOD THEREOF AND SEMICONDUCTOR DEVICE